



## SSC8LA4GT8

### N-Channel Enhanced MOSFET

#### ➤ Features

VDS	VGS	RDSON Typ.	ID
100V	±20V	105mΩ@10V	9.8A
		135mΩ@4.5V	

#### ➤ Description

This device is N-Channel enhancement MOSFET. Uses advanced trench technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit.

100% DVDS+Rg Test.

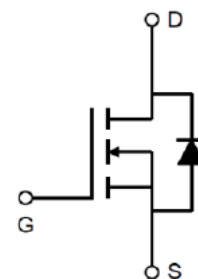
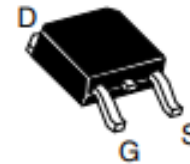
#### ➤ Applications

- DC/DC converters
- Power supplies
- Motor Drive Control
- Synchronous rectification

#### ➤ Ordering Information

Device	Package	Shipping
SSC8LA4GT8	TO-252	2500/Reel

#### ➤ Pin configuration



Marking

(XX: Product Year/YY: Product Week)



➤ **Absolute Maximum Ratings(TA = 25°C unless otherwise noted)**

Symbol	Parameter	Ratings	Unit	
V <sub>DSS</sub>	Drain-to-Source Voltage	100	V	
V <sub>GSS</sub>	Gate-to-Source Voltage	±20	V	
I <sub>D</sub>	Continuous Drain Current <sup>d</sup>	T <sub>C</sub> =25°C	9.8	A
		T <sub>C</sub> =100°C	4.5	
I <sub>DSM</sub>	Continuous Drain Current <sup>a</sup>	T <sub>A</sub> =25°C	4.9	A
		T <sub>A</sub> =70°C	3.2	
I <sub>DM</sub>	Pulsed Drain Current <sup>b</sup>	39	A	
P <sub>D</sub>	Power Dissipation <sup>c</sup>	T <sub>C</sub> =25°C	16	W
		T <sub>C</sub> =100°C	6.5	
P <sub>DSM</sub>	Power Dissipation <sup>a</sup>	T <sub>A</sub> =25°C	4.1	W
		T <sub>A</sub> =70°C	2.6	
T <sub>J</sub>	Operation junction temperature	-55~150	°C	
T <sub>STG</sub>	Storage temperature range	-55~150		

➤ **Thermal Resistance Ratings(TA = 25°C unless otherwise noted)**

Symbol	Parameter	Ratings	Unit
R <sub>θJA</sub>	Junction-to-Ambient Thermal Resistance <sup>a</sup>	30.5	°C/W
R <sub>θJC</sub>	Junction-to-Case Thermal Resistance	7.7	

Note:

- The value of R<sub>θJA</sub> is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz.copper, in a still air environment with T<sub>A</sub>=25°C. The value in any given application depends on the user is specific board design. The power dissipation is based on the t ≤ 10s thermal resistance rating.
- Repetitive rating, pulse width limited by junction temperature.
- The power dissipation P<sub>D</sub> is based on T<sub>J(MAX)</sub>=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- The maximum current rating is package limited.

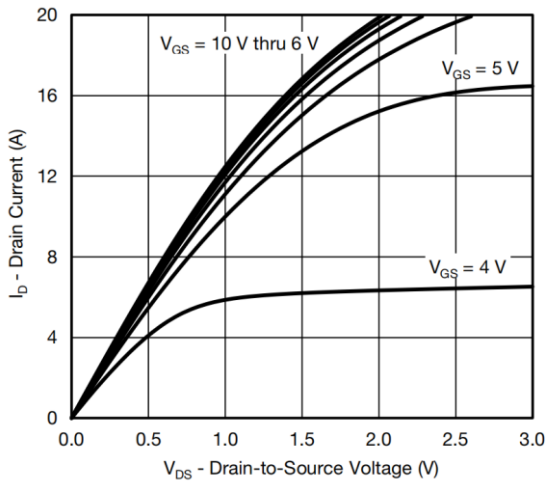


➤ **Electronics Characteristics(TA = 25°C unless otherwise noted)**

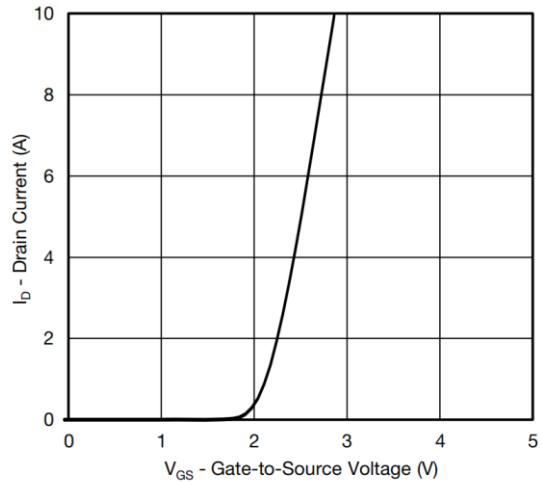
Symbol	Parameter	Test Conditions	Min	Typ.	Max	Unit
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	100			V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.2	1.6	2.5	V
$R_{DS(on)}$	Drain-Source On-Resistance	$V_{GS} = 10V, I_D = 3A$		105	130	mΩ
		$V_{GS} = 4.5V, I_D = 2A$		135	150	
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 100V, V_{GS} = 0V$			1	μA
$I_{GSS}$	Gate-Source leak current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
$G_{FS}$	Transconductance	$V_{DS} = 5V, I_D = 2A$		9		S
$V_{SD}$	Forward Voltage	$V_{GS} = 0V, I_S = 2A$		0.9	1.3	V
$R_g$	Gate Resistance	$V_{GS} = 0V, f = 1MHz$		4		R
$C_{iss}$	Input Capacitance	$V_{DS} = 50V, V_{GS} = 0V, f=1MHz$		163		pF
$C_{oss}$	Output Capacitance			100		
$C_{rss}$	Reverse Transfer Capacitance			14		
$T_{D(ON)}$	Turn-on delay time	$V_{GS} = 10V, R_L = 5R$ $V_{DS} = 50V, R_G = 3R$		6		ns
$T_r$	Rise time			4		
$T_{D(OFF)}$	Turn-off delay time			22		
$T_f$	Fall time			7		
$Q_G$	Total Gate Charge	$V_{GS} = 10V, V_{DS} = 50V$ $I_D = 10A$		5		nC
$Q_{GS}$	Gate Source Charge			1.4		
$Q_{GD}$	Gate Drain Charge			1.2		
$T_{rr}$	Diode Recovery Time	$I_F = 5A, di/dt = 500A/\mu s$		19		ns
$Q_{rr}$	Diode Recovery Charge	$I_F = 5A, di/dt = 500A/\mu s$		55		nC



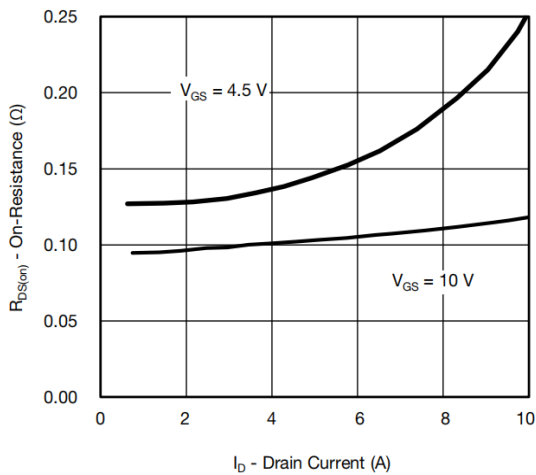
➤ Typical Characteristics (TA = 25°C unless otherwise noted)



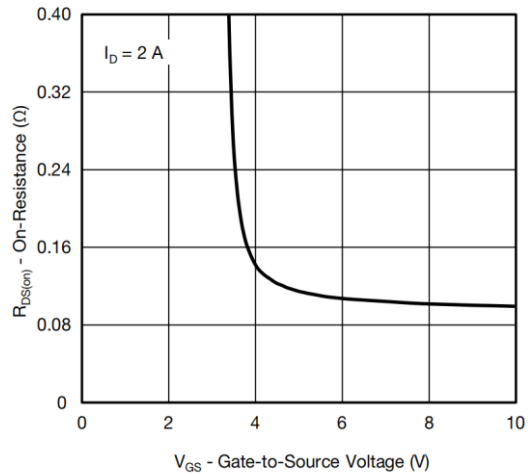
Output Characteristics



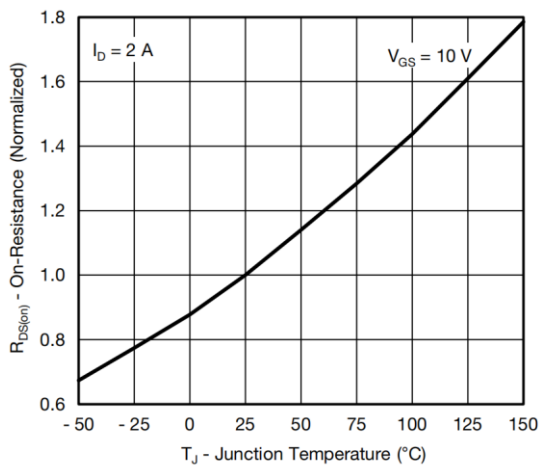
Transfer Characteristics



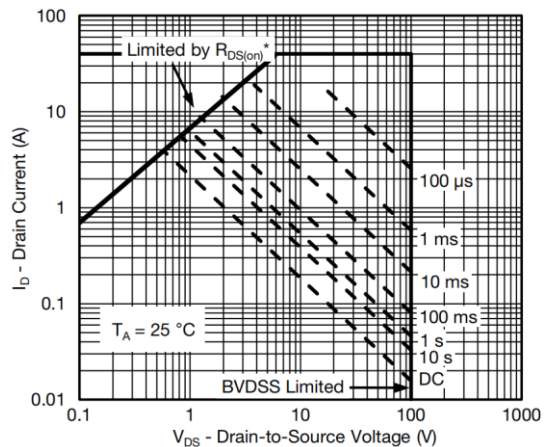
On-Resistance vs. Drain Current



On-Resistance vs. Gate-to-Source Voltage



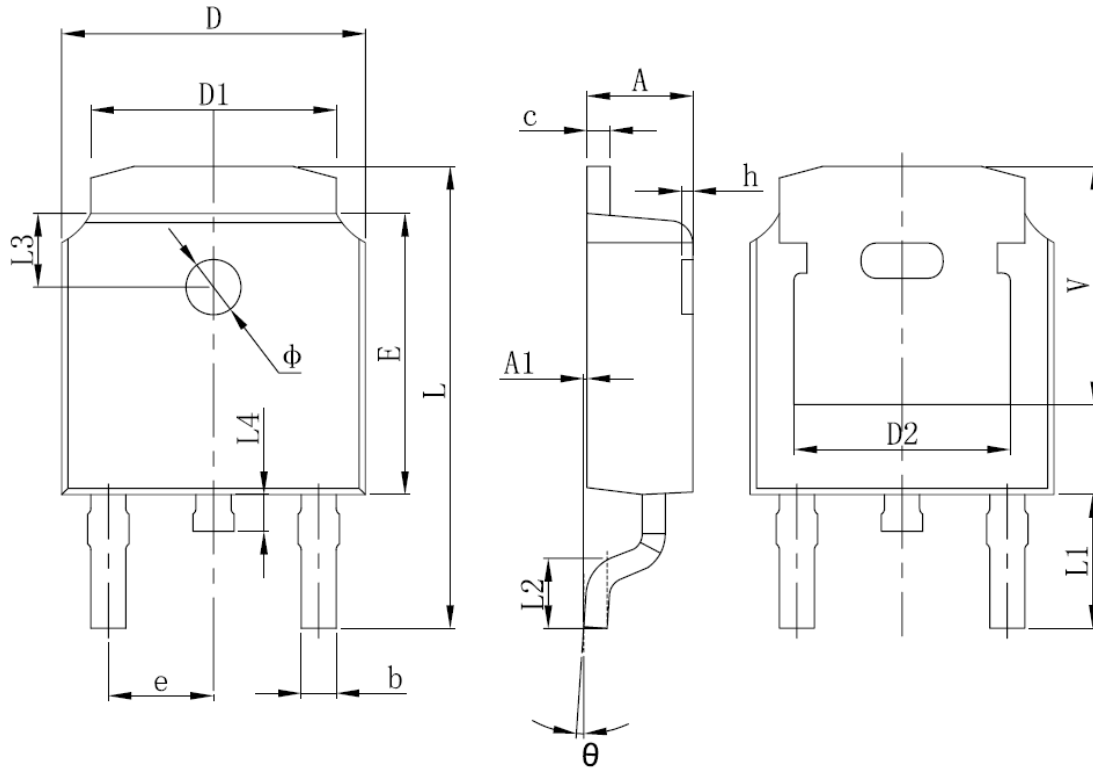
On-Resistance vs. Junction Temperature



Safe Operating Area, Junction-to-Ambient



➤ Package Information



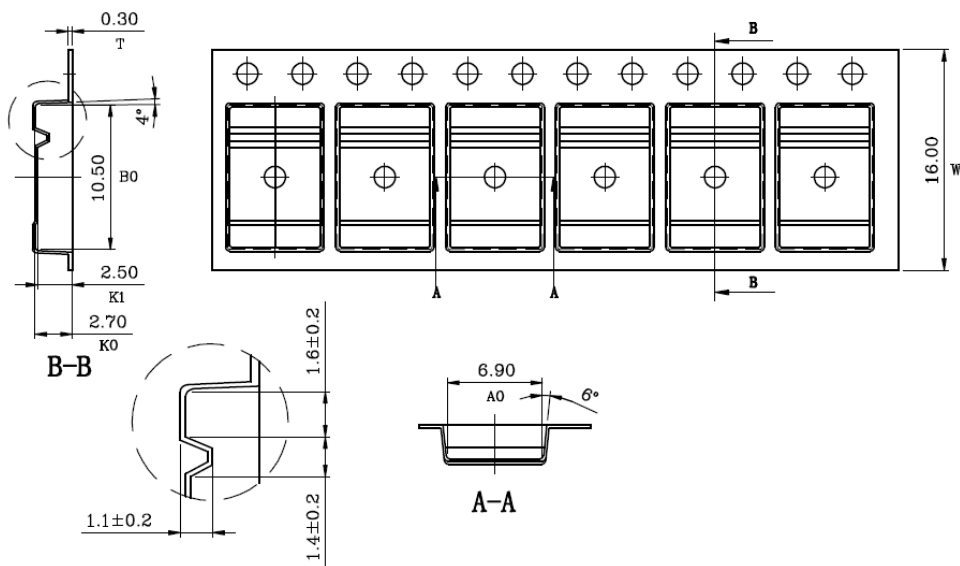
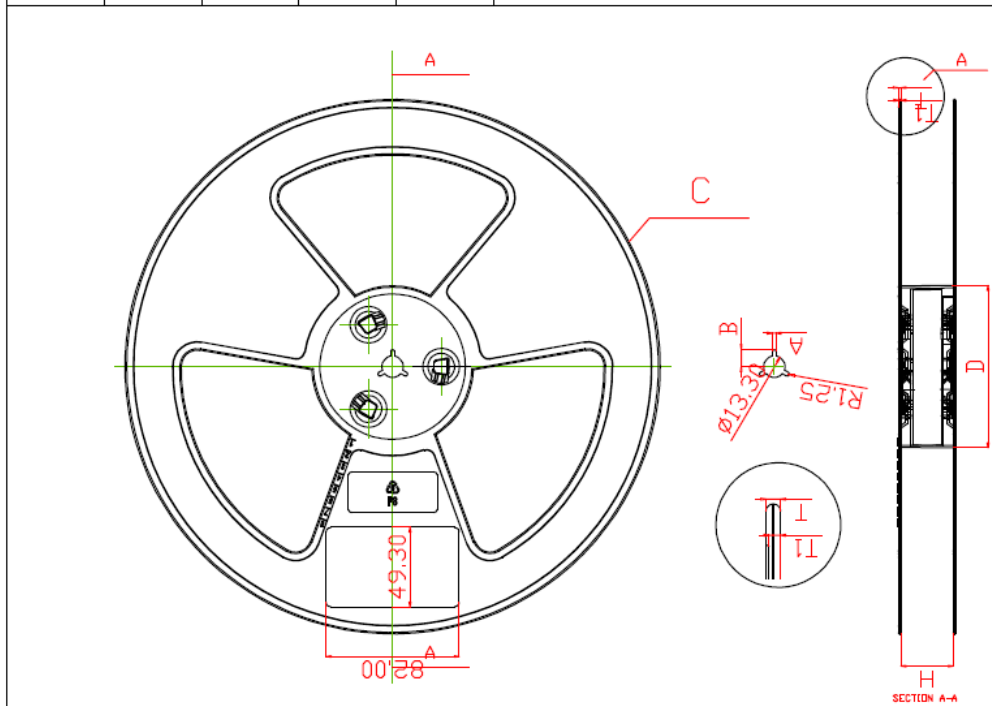
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.635	0.770	0.025	0.030
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.712	10.312	0.382	0.406
L1	2.900 REF.		0.114 REF.	
L2	1.400	1.700	0.055	0.067
L3	1.600 REF.		0.063 REF.	
L4	0.600	1.000	0.024	0.039
phi	1.100	1.300	0.043	0.051
theta	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.250 REF.		0.207 REF.	



➤ Tape and Reel

材质: PS 未标注公差:  $\pm 0.2$

H	12	16	24	32
C $\pm 0.2$	330	330	330	330
T1 $\pm 0.2$	1.45	1.45	1.45	1.45
B $\pm 0.2$	10.7	10.7	10.7	10.7
A $\pm 0.2$	2.5	2.5	2.5	2.5
T $\pm 0.2$	1.85	1.85	1.85	1.85
D $\pm 0.2$	100	100	100	100



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